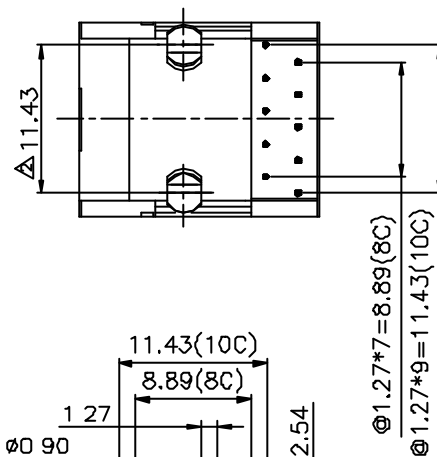
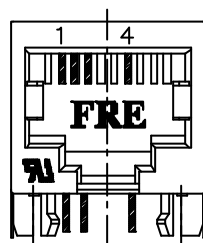
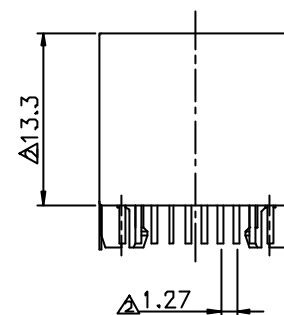
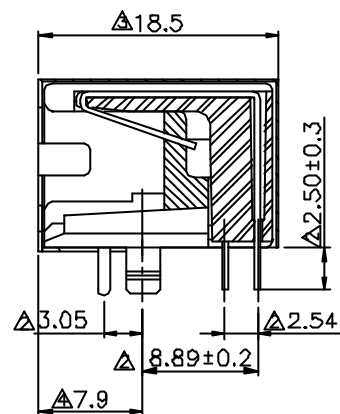
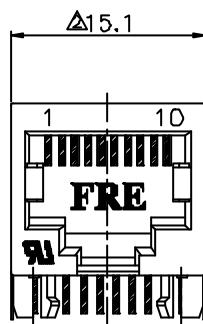


REVISION RECORD				
REV	ECO	DESCRIPTION	DFT	CHKD
△		尺寸變更	SYANG 3/27/98	
△		尺寸變更	SYANG 7/13/98	
△		18.5 was 18.7	JACKY 8/2/99	
△		增加料號規格	YUAN 8/2/99	
△		ADD DIMENSION	CH 3/17/03	



NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE Ø0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

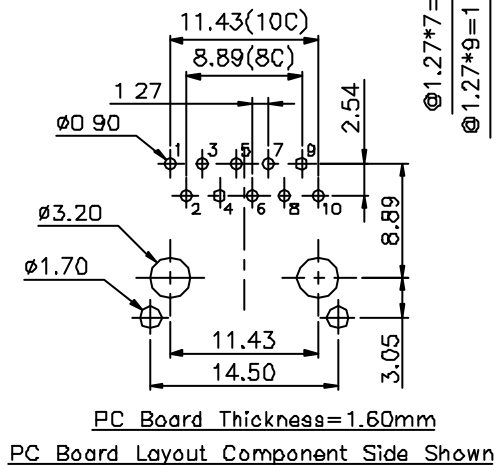
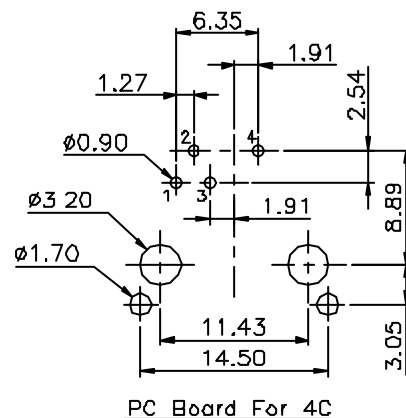
1. STORAGE : -40°C TO +85°C.
 2. OPERATION: 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
UL & CUL FILE NO. E163191
PART NUMBER.E560X-X400BX

4- 4C
8- 8C
1-10C

1- 3u"
2- 6u"
3-15u"

4-30u"
5- 50u"
6-Pd20u"

0- TIN
4- NICKEL



DETACHED LETTER	WM (INCH)	DFTO SYANG	DATE 1/23/98	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED	CHKD MNG-WEI	DATE 03/17/03		
	WM	WFD LWJ	DATE 03/17/03		
	APPLY YUAN	DATE 03/17/03			
WM	±0.2			TITLE 17.6 SIDE ENTRY PCB JACK 10P	
WM	±0.15				
WM	±0.075			DRAWING NO. 5-0124-1 /PART NO. SEE NOTE	
ANGLES ±0.5					
THIRD ANGLE PROJECTION				DO NOT SCALE DRAWING	
				SHEET OF	